

# 2SC5026

# Silicon NPN epitaxial planar type

For low-frequency output amplification Complementary to 2SA1890

## ■ Features

- Low collector-emitter saturation voltage V<sub>CE(sat)</sub>
- High collector-emitter voltage (Base open) V<sub>CEO</sub>
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

# ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	80	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	80	V
Emitter-base voltage (Collector open)	$V_{EBO}$	5	V
Collector current	$I_{C}$	1	A
Peak collector current	$I_{CP}$	1.5	A
Collector power dissipation *	P <sub>C</sub>	1	W
Junction temperature	$T_{j}$	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

Note) \*: Copper plate at the collector is more than 1 cm $^2$  in area, 1.7 mm in thickness Absolute maximum rating without heat sink for  $P_C$  is 0.5 W

# Unit: mm 4.5±0.1 1.6±0.2 1.5±0.1 1.

Marking Symbol: 2A

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# ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

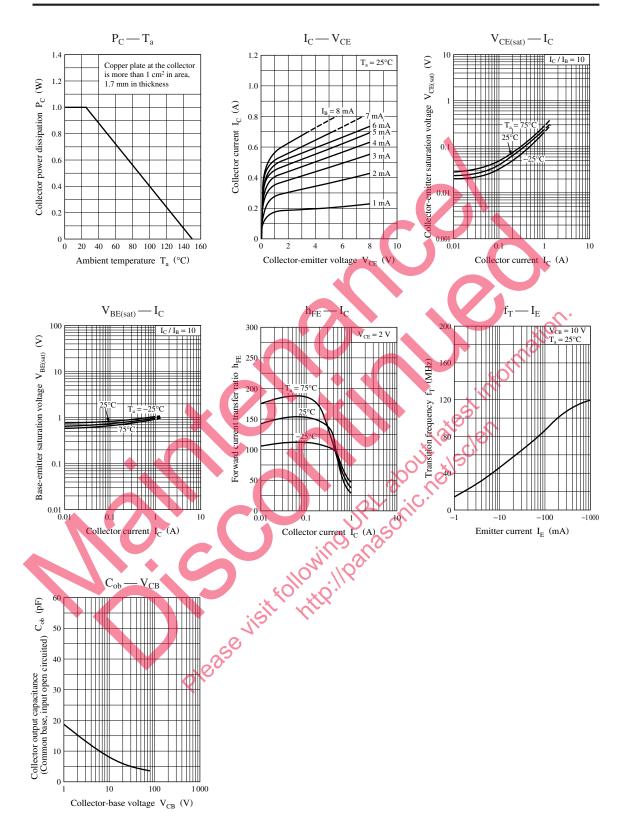
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10  \mu A$ , $I_{\rm E} = 0$	80			V
Collector-emitter voltage (Base open)	$V_{CEO}$	$I_C = 1$ mA, $I_B = 0$	80			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$J_E = 10  \mu A$ , $J_C = 0$	5			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 40 \text{ V}, I_E = 0$			0.1	μΑ
Forward current transfer ratio	h <sub>EEI</sub> *2	$V_{CE} = 2 \text{ V}, I_{C} = 100 \text{ mA}$	120		340	_
	h <sub>FE2</sub> *1	$V_{CE} = 2 \text{ V}, I_{C} = 500 \text{ mA}$	60			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.15	0.3	V
Base-emitter saturation voltage *	V <sub>BE(sat)</sub>	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.85	1.2	V
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		10	20	pF
(Common base, input open circuited)						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

## 2. \*1: Pulse measurement

### \*2: Rank classification

Rank	R	S
$h_{\mathrm{FE1}}$	120 to 240	170 to 340



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